



Datasheet

PCB Slide Switch SPDT On-On 0.4 VA @ 20V ac/dc

RS Stock number 429-498



SPECIFICATIONS

CONTACT RATING: Dependent upon contact material MECHANICAL LIFE: 30,000 make-and-break cycles. CONTACT RESISTANCE: 20m Ω max. initial @ 2-4VDC 100mA for both silver and gold plated contacts.

INSULATION RESISTANCE: $1,000M \Omega min.$

DIELETRIC STRENGTH: 1,000 V RMS@sea level.

OPERATING TEMPERATURE: -30°C to 85°C.

MATERIALS

CASE - Diallyl phthalate (DAP)(UL94V-0)

HOUSING - Brass,tin plated

ACTUATOR - Nylon, black.

CONTACT - Silver or gold plated.

TERMINALS - Copper alloy, with silver and gold plated.



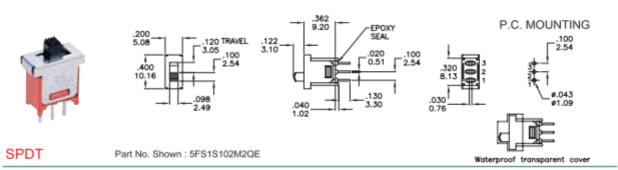


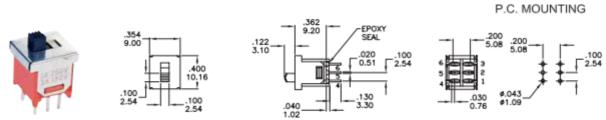
SWITCH FUNCTION

	UL/CSA		SWITCH FUNCTION			CONNECTED TERMINALS / SCHEMATIC		
NO. POLES	MODEL	MODEL	POS.1	POS.2	POS.3	POS.1	POS.2	POS.3
I OLLS	NO.	NO.		4	4		1	4
SP	Q2511	5FS1	ON	NONE	ON	2-1 1/ -3	OPEN	2-3 \2000
	Q2512	5FS2	ON	NONE	MOM			
	Q2513	5FS3	ON	OFF	ON			1. /3
DP	Q2521	5FD1	ON	NONE	ON	2-1,5-4	OPEN	2-3,5-6
	Q2523	5FD3	ON	OFF	ON	1 + 3 4 -6		1- /3 4- /2

MOM=MOMENTARY

POLE OPTIONS

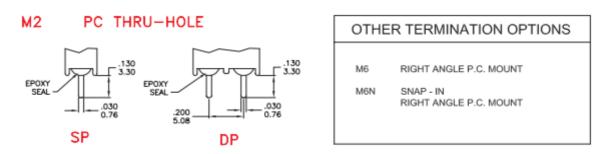




DPDT

Part No. Shown: 5FD1S102M2QE

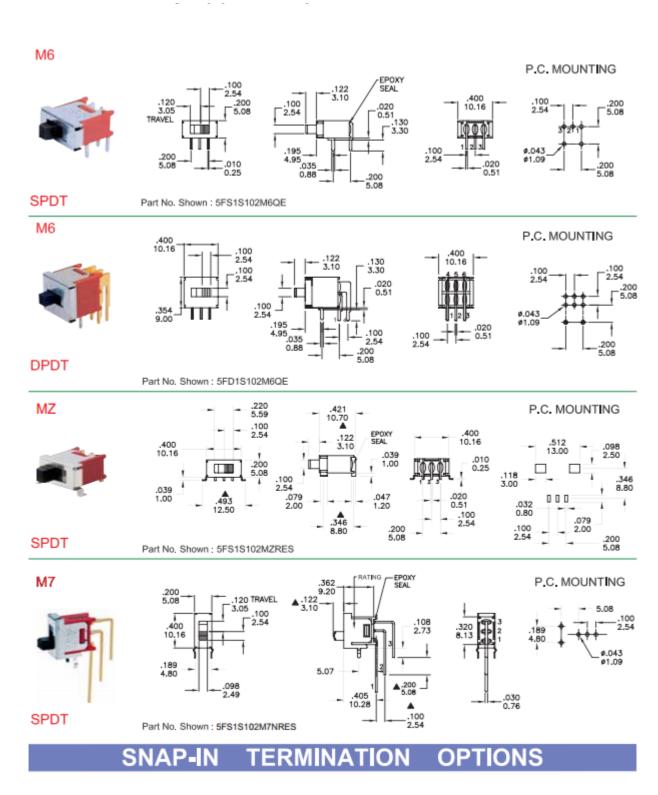
TERMINATION OPTIONS



RS, Professionally Approved Products, gives you professional quality parts across all products categories. Our range has been testified by engineers as giving comparable quality to that of the leading brands without paying a premium price.



ENGLISH



M6N









CONTACT MATERIAL OPTIONS

Q=Silver R=Gold	<u>Q.C.S.K</u>	<u>R.G</u>		
G=Gold,tin-lead S=Silver,tin-lead	FIXED TERMINAL: Silver plated over copper alloy	FIXED TERMINAL:Copper alloy with gold plated over nickel plated		
	MOVABLE CONTACT: Silver plated over copper alloy	MOVABLE CONTACT: Copper alloy with gold plated over nicket plated		
K=Gold over silver ,tin-lead	RATING:3 Amps with resistant load @ 120VAC or 28VDC 1 Amps with resistant load @ 250VAC			







SOLDERING PROCESSES

MANUAL SOLDERING: Use soldering iron of 30 watts, controlled at 350°C

approximately 5 seconds while applying solder.

WAVE SOLDERING: Recommended Soldering Temperature: 260±5°C

Duration of Solder Immersion: 5 ±1 seconds

(PCB is 1.6mm in thickness)

SOLDERING: Vapor phase

Temperature Profile Zone Room temperature Time (Sec) Pre-heat (A) 150°C Min 120s Soak (B) 180°C~200°C Min 150s Peak (C) 200°C~235°C Min 30s (D) 235°C~260°C Peak Min 40s (E) Peak 260°C Max 10s (°C) Peak : 260°C 250 200 150 100 50 В C D Room Temperature Time (Sec)